Products Documentation Resources My Account Customer Support

<u>Home</u> > <u>Products</u> > <u>Socket/Card Products</u> > <u>Product Feature Selector</u> > Product Details

1612618-4 Product Details

Have a Question?

Chat with a Product Information Specialist

Quick Links

▶ Check Pricing & Availability
 ▶ Search for Tooling

Search for Tooling
Product Feature Selector
Contact Us About This Product





Memory Sockets

Always EU RoHS/ELV Compliant (Statement of Compliance)

Product Highlights:

- Socket Type = Memory Card
 Socket Style = SO DIMM
 Gold Flash Contact Plating, Mating Area, Material
- 200 Positions
 DRAM Type = Double Data Rate (DDR)

View all Features

TE Internal Number: 1612618-4



View 3D PDF









Documentation & Additional Information

Product Drawings:

• DDR1 & DDR2 SODIMM SOCKET 0.6mm PITCH 200POS 9.2mm H... (PDF, English)

Catalog Pages/Data Sheets:

Product Specifications:

• DDR S.O.DIMM Socket 200 Positions (PDF, English)

Application Specifications:

Instruction Sheets:

CAD Files: (CAD Format & Compression Information)

- <u>2D Drawing</u> (DXF, Version E1)
 <u>3D Model</u> (IGES, Version E1)
- 3D Model (STEP, Version E1)

List all Documents

Additional Information:

Related Products:

Tooling

Product Features (Please use the Product Drawing for all design activity)

- Product Type Features:

 Socket Style = SO DIMM

 DRAM Type = Double Data Rate (DDR)
 - PCB Mount Style = Surface Mount
 - Module Orientation = Right Angle
 - Profile = Ultra High
 - Comment = Semi Hard Tray with 20 sockets PN 1279284-1

Mechanical Attachment:

Keying = Standard

Electrical Characteristics:

DRAM Voltage = 1.8 V

Termination Related Features: • Solder Tail Contact Plating = Gold Flash

Body Related Features:

- Socket Type = Memory Card
- Number of Positions = 200
- Row-to-Row Spacing (mm [in]) = 6.20 [0.244]
- Centerline (mm [in]) = 0.60 [0.024]
- · Number of Rows = Dual
- Ejector Type = Locking
- Ejector Location = Both Ends
- Number of Keys = 1
- · Latch Material = Stainless Steel
- · Latch Plating = Tin
- Boss = With
- Mount Type = Printed Circuit Board

Contact Related Features:

- Contact Plating, Mating Area, Material = Gold Flash
- Contact Base Material = Copper Allov

- Housing Related Features:

 Housing Material = High Temperature Thermoplastic
 - Housing Color = Black
 - UL Flammability Rating = UL 94V-0

Configuration Related Features:

- Stack Height (mm [in]) = 9.20 [0.362]
- Insertion Style = Cam-In
- Center Key (mm [in]) = None

- RoHS/ELV Compliance = RoHS compliant, ELV compliant
- Lead Free Solder Processes = Reflow solder capable to 245°C
- RoHS/ELV Compliance History = Always was RoHS compliant

Operation/Application:

Application Type = DDR SDRAM

Packaging Related Features:

- Packaging Method = Semi-Hard Tray Assembly
- Packaging Quantity = 20

Other:
• Brand = AMP

🟮 BOOKMARK 📑 😭 🧦 ...

Corporate Information

Quick Links

Who We Are Check Distributor Inventory Investors Cross Reference

News Room Find Documents & Drawings Supplier Portal Product Compliance Support Center Site Map Careers

© 2010 Tyco Electronics All Rights Reserved | Privacy Policy

Customer Support

Email or Chat with Us Find a Phone Number

Search Knowledge Base Manage Your Account

Sign up for our eNewsletter







